

Electronic Patent Application Fee Transmittal

Application Number:	10792069			
Filing Date:	03-Mar-2004			
Title of Invention:	INTEGRATED MULTI-STEP GAP FILL AND ALL FEATURE PLANARIZATION FOR CONDUCTIVE MATERIALS			
First Named Inventor/Applicant Name:	Wei-Yung Hsu			
Filer:	Chang Kim/Barbara Holt			
Attorney Docket Number:	AMAT/5614.D1/CMP/CMP/RKK			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	1501	1	1440	1440
Publ. Fee- early, voluntary, or normal	1504	1	300	300

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
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Total in USD (\$)				1740